



DMT6009LPS

PowerDI

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	Ι <sub>D</sub> T <sub>C</sub> = +25°C
60V	10mΩ @ V <sub>GS</sub> = 10V	87A
007	12mΩ @ V <sub>GS</sub> = 4.5V	79A

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$ , yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- High Frequency Switching
- Sync. Rectification
- DC-DC Converters

PowerDI5060-8 Pin1

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Features

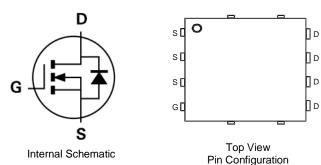
 100% Unclamped Inductive Switching – Ensures More Reliable and Robust End Application

60V N-CHANNEL ENHANCEMENT MODE MOSFET

- Low R<sub>DS(ON)</sub> Minimizes Power Losses
- Low Q<sub>G</sub> Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Case	Packaging
DMT6009LPS-13	PowerDI5060-8	2,500/Tape & Reel

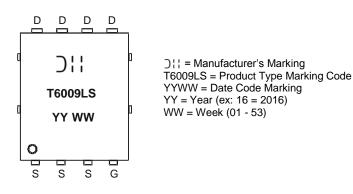
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



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# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Drain-Source Voltage		V <sub>DSS</sub>	60	V
Gate-Source Voltage		V <sub>GSS</sub>	±16	V
Continuous Drain Current (Note 5)	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	10.6 9.1	А
Continuous Drain Current (Note 6)	T <sub>C</sub> = +25°C T <sub>C</sub> = +70°C	ID	87 69	A
Maximum Continuous Body Diode Forward Current (Note 6)	Is	100	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	160	А
Avalanche Current, L=0.1mH		I <sub>AS</sub>	20.3	А
Avalanche Energy, L=0.1mH		EAS	20.6	mJ

### **Thermal Characteristics**

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)		R <sub>0JA</sub>	53	°C/W
Total Power Dissipation (Note 6)	T <sub>C</sub> = +25°C	PD	113	W
Thermal Resistance, Junction to Case (Note 6)	·	R <sub>θJC</sub>	1.1	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

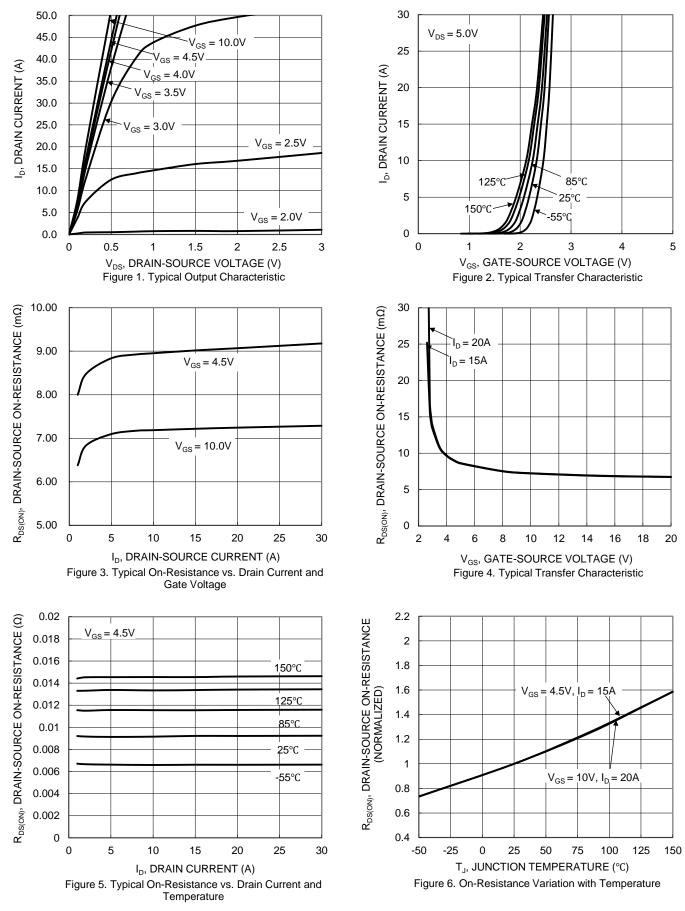
Characteristic	Cumphiel	Min	True	Max	11	Test Condition	
	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	51	00					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_		V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	—	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	—	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)			1	I.	r		
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.7	—	2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Proven		7.2	<u>10</u> mΩ	$V_{GS} = 10V, I_D = 20A$		
	R <sub>DS(ON)</sub>		8.9	12	11152	$V_{GS} = 4.5V, I_D = 15A$	
Diode Forward Voltage	V <sub>SD</sub>		0.9	—	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	CISS		1,925	—		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss		438	—	pF		
Reverse Transfer Capacitance	C <sub>RSS</sub>	_	41	_			
Gate Resistance	R <sub>G</sub>	_	1.7		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	Q <sub>G</sub>	_	33.5			V <sub>DS</sub> = 30V, I <sub>D</sub> = 13.5A	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Q <sub>G</sub>	_	15.6	_	nC		
Gate-Source Charge	Q <sub>GS</sub>	_	4.7	_	nc		
Gate-Drain Charge	Q <sub>GD</sub>	_	5.3	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.5			V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V,	
Turn-On Rise Time	t <sub>R</sub>	_	8.6	_			
Turn-Off Delay Time	t <sub>D(OFF)</sub>		35.9		ns	$R_{G} = 6\Omega, I_{D} = 13.5A$	
Turn-Off Fall Time	tF		15.7				
Body Diode Reverse Recovery Time	t <sub>RR</sub>		18.2		ns		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	33.1	—	nC	I <sub>F</sub> = 13.5A, di/dt = 400A/μs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

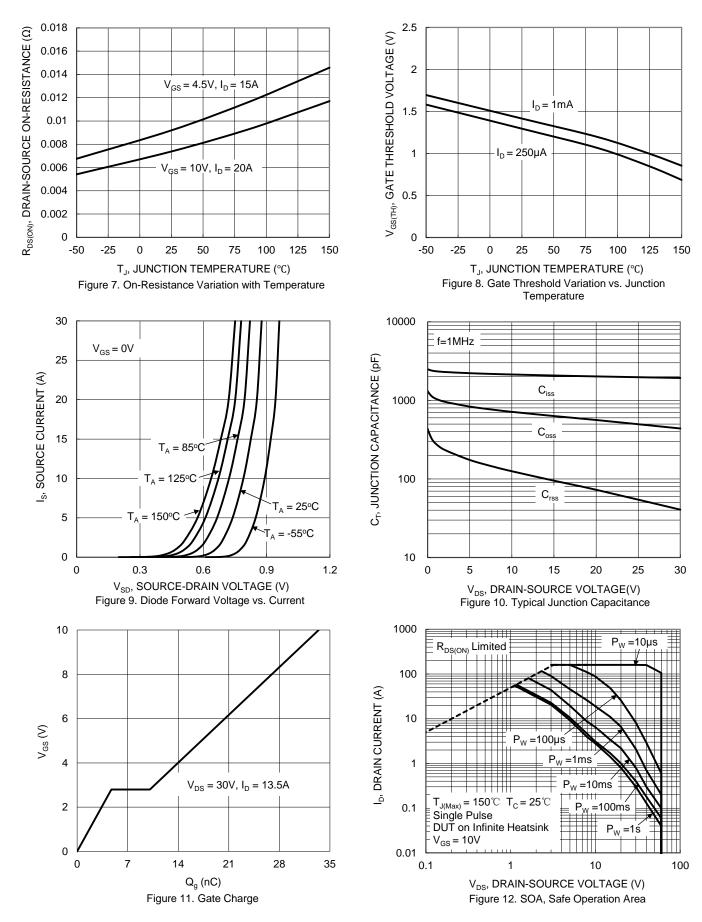




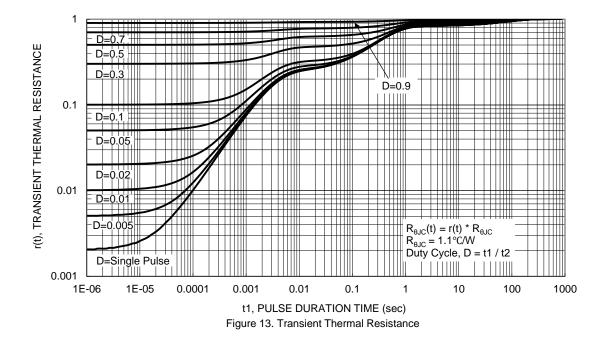
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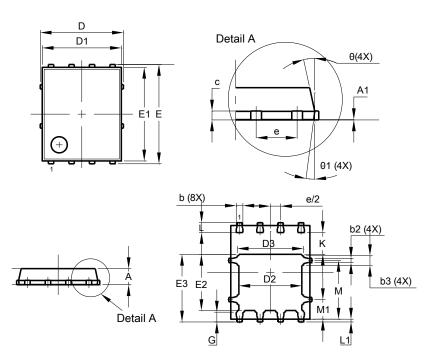






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



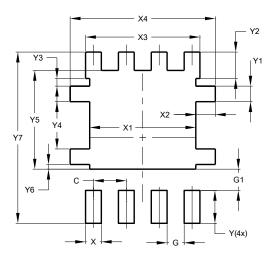
PowerDI5060-8

PowerDI5060-8						
Dim	Min Max		Тур			
Α	0.90	1.10	1.00			
A1	0.00	0.05	I			
b	0.33	0.51	0.41			
b2	0.200	0.350	0.273			
b3	0.40	0.80	0.60			
С	0.230	0.330	0.277			
D	Į	5.15 BSC	;			
D1	4.70	5.10	4.90			
D2	3.70	4.10	3.90			
D3	3.90	4.30	4.10			
Е	6.15 BSC					
E1	5.60	6.00	5.80			
E2	3.28	3.68	3.48			
E3	3.99	4.39	4.19			
е	1.27 BSC					
G	0.51	0.71	0.61			
K	0.51	-	1			
L	0.51	0.71	0.61			
L1	0.100	0.200	0.175			
М	3.235	4.035	3.635			
M1	1.00	1.40	1.21			
θ	10°	12°	11°			
θ1	6°	8°	7°			
Al	All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

the latest version.



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